

# 400 MHz Low Voltage PECL Clock Synthesizer

**MPC92429**

The MPC92429 is a 3.3 V compatible, PLL based clock synthesizer targeted for high performance clock generation in mid-range to high-performance telecom, networking and computing applications. With output frequencies from 25 MHz to 400 MHz and the support of differential PECL output signals the device meets the needs of the most demanding clock applications.

## Features

- 25 MHz to 400 MHz synthesized clock output signal
- Differential PECL output
- LVCMOS compatible control inputs
- On-chip crystal oscillator for reference frequency generation
- 3.3 V power supply
- Fully integrated PLL
- Minimal frequency overshoot
- Serial 3-wire programming interface
- Parallel programming interface for power-up
- 32-lead LQFP and 28-PLCC packaging
- 32-lead and 28-lead Pb-free package available
- SiGe Technology
- Ambient temperature range 0°C to +70°C
- Pin and function compatible to the MC12429 and MPC9229

## Functional Description

The internal crystal oscillator uses the external quartz crystal as the basis of its frequency reference. The frequency of the internal crystal oscillator is divided by 16 and then multiplied by the PLL. The VCO within the PLL operates over a range of 800 to 1600 MHz. Its output is scaled by a divider that is configured by either the serial or parallel interfaces. The crystal oscillator frequency  $f_{XTAL}$ , the PLL feedback-divider M and the PLL post-divider N determine the output frequency.

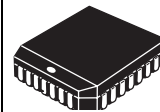
The feedback path of the PLL is internal. The PLL adjusts the VCO output frequency to be  $4 \times M$  times the reference frequency by adjusting the VCO control voltage. Note that for some values of M (either too high or too low) the PLL will not achieve phase lock. The PLL will be stable if the VCO frequency is within the specified VCO frequency range (800 to 1600 MHz). The M-value must be programmed by the serial or parallel interface.

The PLL post-divider N is configured through either the serial or the parallel interfaces, and can provide one of four division ratios (1, 2, 4, or 8). This divider extends performance of the part while providing a 50% duty cycle. The output driver is driven differentially from the output divider, and is capable of driving a pair of transmission lines terminated  $50 \Omega$  to  $V_{CC} - 2.0$  V. The positive supply voltage for the internal PLL is separated from the power supply for the core logic and output drivers to minimize noise induced jitter.

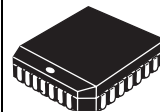
The configuration logic has two sections: serial and parallel. The parallel interface uses the values at the M[8:0] and N[1:0] inputs to configure the internal counters. It is recommended on system reset to hold the P\_LOAD input LOW until power becomes valid. On the LOW-to-HIGH transition of P\_LOAD, the parallel inputs are captured. The parallel interface has priority over the serial interface. Internal pullup resistors are provided on the M[8:0] and N[1:0] inputs prevent the LVCMOS compatible control inputs from floating.

The serial interface centers on a fourteen bit shift register. The shift register shifts once per rising edge of the S\_CLOCK input. The serial input S\_DATA must meet setup and hold timing as specified in the AC Characteristics section of this document. The configuration latches will capture the value of the shift register on the HIGH-to-LOW edge of the S\_LOAD input. See PROGRAMMING INTERFACE for more information. The TEST output reflects various internal node values, and is controlled by the T[2:0] bits in the serial data stream. In order to minimize the PLL jitter, it is recommended to avoid active signal on the TEST output.

## 400 MHZ LOW VOLTAGE CLOCK SYNTHESIZER



**FN SUFFIX**  
**28-LEAD PLCC PACKAGE**  
**CASE 776-02**



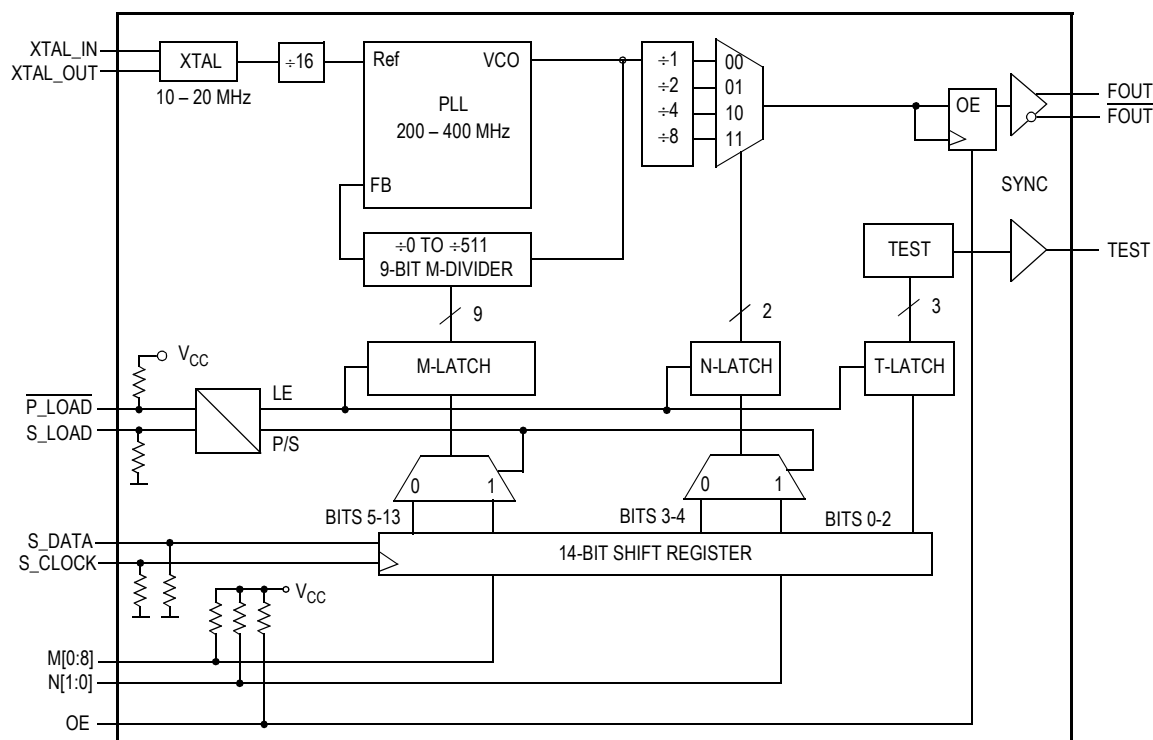
**EI SUFFIX**  
**28-LEAD PLCC PACKAGE**  
**Pb-FREE PACKAGE**  
**CASE 776-02**



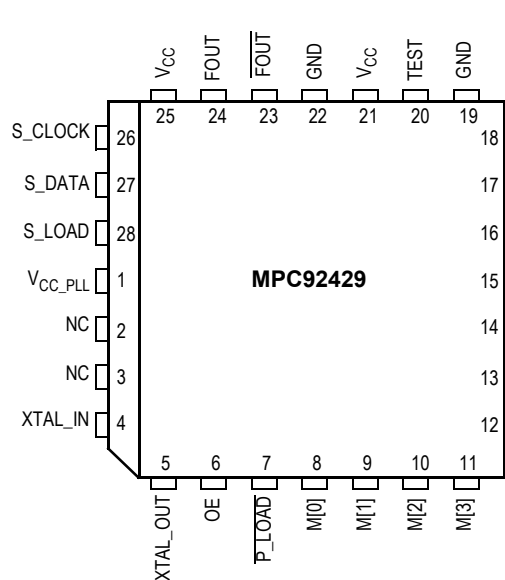
**FA SUFFIX**  
**32-LEAD LQFP PACKAGE**  
**CASE 873A-03**



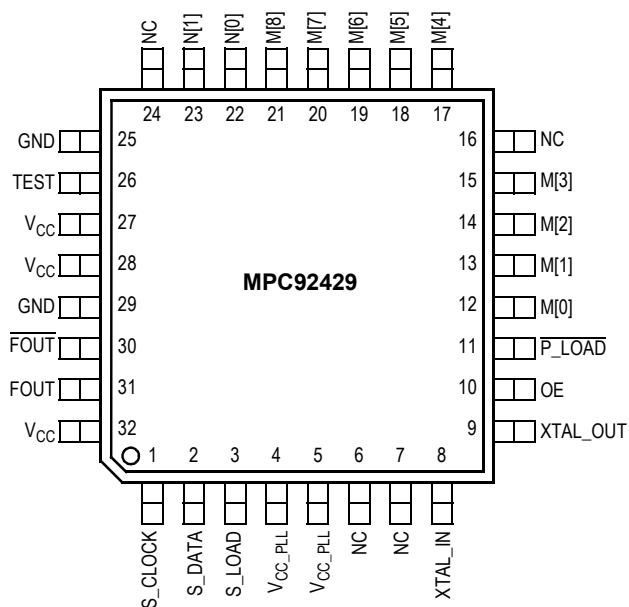
**AC SUFFIX**  
**32-LEAD LQFP PACKAGE**  
**Pb-FREE PACKAGE**  
**CASE 873A-03**



### Figure 1. MPC92429 Logic Diagram



**Figure 2. MPC92429 28-Lead PLCC Pinout**  
(Top View)



**Figure 3. MPC92429 32-Lead Package Pinout  
(Top View)**

Table 1. Pin Configurations

| Pin                            | I/O    | Default | Type            | Function                                                                                                                                                                                                                                                                                                                                                               |
|--------------------------------|--------|---------|-----------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| XTAL_IN, XTAL_OUT              |        |         | Analog          | Crystal oscillator interface.                                                                                                                                                                                                                                                                                                                                          |
| FOUT, $\overline{\text{FOUT}}$ | Output |         | LVPECL          | Differential clock output.                                                                                                                                                                                                                                                                                                                                             |
| TEST                           | Output |         | LVC MOS         | Test and device diagnosis output.                                                                                                                                                                                                                                                                                                                                      |
| S_LOAD                         | Input  | 0       | LVC MOS         | Serial configuration control input.<br>This input controls the loading of the configuration latches with the contents of the shift register. The latches will be transparent when this signal is high, thus the data must be stable on the high-to-low transition.                                                                                                     |
| $\overline{\text{P\_LOAD}}$    | Input  | 1       | LVC MOS         | Parallel configuration control input.<br>This input controls the loading of the configuration latches with the content of the parallel inputs (M and N). The latches will be transparent when this signal is low, thus the parallel data must be stable on the low-to-high transition of $\overline{\text{P\_LOAD}}$ . $\overline{\text{P\_LOAD}}$ is state sensitive. |
| S_DATA                         | Input  | 0       | LVC MOS         | Serial configuration data input.                                                                                                                                                                                                                                                                                                                                       |
| S_CLOCK                        | Input  | 0       | LVC MOS         | Serial configuration clock input.                                                                                                                                                                                                                                                                                                                                      |
| M[0:8]                         | Input  | 1       | LVC MOS         | Parallel configuration for PLL feedback divider (M).<br>M is sampled on the low-to-high transition of $\overline{\text{P\_LOAD}}$ .                                                                                                                                                                                                                                    |
| N[1:0]                         | Input  | 1       | LVC MOS         | Parallel configuration for Post-PLL divider (N).<br>N is sampled on the low-to-high transition of $\overline{\text{P\_LOAD}}$ .                                                                                                                                                                                                                                        |
| OE                             | Input  | 1       | LVC MOS         | Output enable (active high).<br>The output enable is synchronous to the output clock to eliminate the possibility of runt pulses on the F <sub>OUT</sub> output. OE = L low stops F <sub>OUT</sub> in the logic low state (F <sub>OUT</sub> = L, $\overline{\text{FOUT}}$ = H).                                                                                        |
| GND                            | Supply | Supply  | Ground          | Negative power supply (GND).                                                                                                                                                                                                                                                                                                                                           |
| V <sub>CC</sub>                | Supply | Supply  | V <sub>CC</sub> | Positive power supply for I/O and core. All V <sub>CC</sub> pins must be connected to the positive power supply for correct operation.                                                                                                                                                                                                                                 |
| V <sub>CC_PLL</sub>            | Supply | Supply  | V <sub>CC</sub> | PLL positive power supply (analog power supply).                                                                                                                                                                                                                                                                                                                       |

Table 2. Output Frequency Range and PLL Post-Divider N

| N |   | Output Division | Output Frequency Range |
|---|---|-----------------|------------------------|
| 1 | 0 |                 |                        |
| 0 | 0 | 1               | 200 – 400 MHz          |
| 0 | 1 | 2               | 100 – 200 MHz          |
| 1 | 0 | 4               | 50 – 100 MHz           |
| 1 | 1 | 8               | 25 – 50 MHz            |

Table 3. General Specifications

| Symbol        | Characteristics                                                                      | Min  | Typ          | Max  | Unit | Condition                      |
|---------------|--------------------------------------------------------------------------------------|------|--------------|------|------|--------------------------------|
| $V_{TT}$      | Output Termination Voltage                                                           |      | $V_{CC} - 2$ |      | V    |                                |
| MM            | ESD Protection (Machine Model)                                                       | 200  |              |      | V    |                                |
| HBM           | ESD Protection (Human Body Model)                                                    | 2000 |              |      | V    |                                |
| LU            | Latch-Up Immunity                                                                    | 200  |              |      | mA   |                                |
| $C_{IN}$      | Input Capacitance                                                                    |      | 4.0          |      | pF   | Inputs                         |
| $\theta_{JA}$ | LQFP 32 Thermal Resistance Junction to Ambient<br>JESD 51-3, single layer test board |      | 83.1         | 86.0 | °C/W | Natural convection             |
|               |                                                                                      |      | 73.3         | 75.4 | °C/W | 100 ft/min                     |
|               |                                                                                      |      | 68.9         | 70.9 | °C/W | 200 ft/min                     |
|               |                                                                                      |      | 63.8         | 65.3 | °C/W | 400 ft/min                     |
|               |                                                                                      |      | 57.4         | 59.6 | °C/W | 800 ft/min                     |
|               | JESD 51-6, 2S2P multilayer test board                                                |      | 59.0         | 60.6 | °C/W | Natural convection             |
|               |                                                                                      |      | 54.4         | 55.7 | °C/W | 100 ft/min                     |
|               |                                                                                      |      | 52.5         | 53.8 | °C/W | 200 ft/min                     |
|               |                                                                                      |      | 50.4         | 51.5 | °C/W | 400 ft/min                     |
|               |                                                                                      |      | 47.8         | 48.8 | °C/W | 800 ft/min                     |
| $\theta_{JC}$ | LQFP 32 Thermal Resistance Junction to Case                                          |      | 23.0         | 26.3 | °C/W | MIL-SPEC 883E<br>Method 1012.1 |

Table 4. Absolute Maximum Ratings<sup>(1)</sup>

| Symbol    | Characteristics     | Min  | Max            | Unit | Condition |
|-----------|---------------------|------|----------------|------|-----------|
| $V_{CC}$  | Supply Voltage      | -0.3 | 3.9            | V    |           |
| $V_{IN}$  | DC Input Voltage    | -0.3 | $V_{CC} + 0.3$ | V    |           |
| $V_{OUT}$ | DC Output Voltage   | -0.3 | $V_{CC} + 0.3$ | V    |           |
| $I_{IN}$  | DC Input Current    |      | ±20            | mA   |           |
| $I_{OUT}$ | DC Output Current   |      | ±50            | mA   |           |
| $T_S$     | Storage Temperature | -65  | 125            | °C   |           |

1. Absolute maximum continuous ratings are those maximum values beyond which damage to the device may occur. Exposure to these conditions or conditions beyond those indicated may adversely affect device reliability. Functional operation at absolute-maximum-rated conditions is not implied.

Table 5. DC Characteristics ( $V_{CC} = 3.3 \text{ V} \pm 5\%$ ,  $T_A = 0^\circ\text{C}$  to  $+70^\circ\text{C}$ )

| Symbol                                                                                                           | Characteristics                    | Min           | Typ | Max            | Unit | Condition                  |
|------------------------------------------------------------------------------------------------------------------|------------------------------------|---------------|-----|----------------|------|----------------------------|
| LVCMOS Control Inputs ( $\overline{P\_LOAD}$ , $S\_LOAD$ , $S\_DATA$ , $S\_CLOCK$ , $M[0:8]$ , $N[0:1]$ , $OE$ ) |                                    |               |     |                |      |                            |
| $V_{IH}$                                                                                                         | Input High Voltage                 | 2.0           |     | $V_{CC} + 0.3$ | V    | LVCMOS                     |
| $V_{IL}$                                                                                                         | Input Low Voltage                  |               |     | 0.8            | V    | LVCMOS                     |
| $I_{IN}$                                                                                                         | Input Current <sup>(1)</sup>       |               |     | ±200           | μA   | $V_{IN} = V_{CC}$ or GND   |
| Differential Clock Output $F_{OUT}^{(2)}$                                                                        |                                    |               |     |                |      |                            |
| $V_{OH}$                                                                                                         | Output High Voltage <sup>(3)</sup> | $V_{CC}-1.02$ |     | $V_{CC}-0.74$  | V    | LVPECL                     |
| $V_{OL}$                                                                                                         | Output Low Voltage <sup>(3)</sup>  | $V_{CC}-1.95$ |     | $V_{CC}-1.60$  | V    | LVPECL                     |
| Test and Diagnosis Output TEST                                                                                   |                                    |               |     |                |      |                            |
| $V_{OH}$                                                                                                         | Output High Voltage <sup>(3)</sup> | 2.0           |     |                | V    | $I_{OH} = -0.8 \text{ mA}$ |
| $V_{OL}$                                                                                                         | Output Low Voltage <sup>(3)</sup>  |               |     | 0.55           | V    | $I_{OH} = 0.8 \text{ mA}$  |
| Supply Current                                                                                                   |                                    |               |     |                |      |                            |
| $I_{CC\_PLL}$                                                                                                    | Maximum PLL Supply Current         |               |     | 20             | mA   | $V_{CC\_PLL}$ Pins         |
| $I_{CC}$                                                                                                         | Maximum Supply Current             |               |     | 100            | mA   | All $V_{CC}$ Pins          |

1. Inputs have pull-down resistors affecting the input current.  
 2. Outputs terminated  $50 \Omega$  to  $V_{TT} = V_{CC} - 2 \text{ V}$ .  
 3. The MPC92429 TEST output levels are compatible to the MC12429 output levels.

**Table 6. AC Characteristics** ( $V_{CC} = 3.3 \text{ V} \pm 5\%$ ,  $T_A = 0^\circ\text{C}$  to  $+70^\circ\text{C}$ )(<sup>1</sup>)

| Symbol         | Characteristics                                                                                                   | Min  | Typ | Max | Unit | Condition  |
|----------------|-------------------------------------------------------------------------------------------------------------------|------|-----|-----|------|------------|
| $f_{XTAL}$     | Crystal Interface Frequency Range                                                                                 | 10   |     | 20  | MHz  |            |
| $f_{VCO}$      | VCO Frequency Range( <sup>2</sup> )                                                                               | 200  |     | 400 | MHz  |            |
| $f_{MAX}$      | Output Frequency<br>N = 00 ( $\div 1$ )<br>N = 01 ( $\div 2$ )<br>N = 10 ( $\div 4$ )<br>N = 11 ( $\div 8$ )      | 200  |     | 400 | MHz  |            |
|                |                                                                                                                   | 100  |     | 200 | MHz  |            |
|                |                                                                                                                   | 50   |     | 100 | MHz  |            |
|                |                                                                                                                   | 25   |     | 50  | MHz  |            |
| DC             | Output Duty Cycle                                                                                                 | 45   | 50  | 55  | %    |            |
| $t_r, t_f$     | Output Rise/Fall Time                                                                                             | 0.05 |     | 0.3 | ns   | 20% to 80% |
| $f_{S\_CLOCK}$ | Serial Interface Programming Clock Frequency( <sup>3</sup> )                                                      | 0    |     | 10  | MHz  |            |
| $t_{p\_MIN}$   | Minimum Pulse Width (S_LOAD, P_LOAD)                                                                              | 50   |     |     | ns   |            |
| $t_s$          | Setup Time<br>S_DATA to S_CLOCK<br>S_CLOCK to S_LOAD<br>M, N to P_LOAD                                            | 20   |     |     | ns   |            |
|                |                                                                                                                   | 20   |     |     | ns   |            |
|                |                                                                                                                   | 20   |     |     | ns   |            |
| $t_h$          | Hold Time<br>S_DATA to S_CLOCK<br>M, N to P_LOAD                                                                  | 20   |     |     | ns   |            |
|                |                                                                                                                   | 20   |     |     | ns   |            |
| $t_{JIT(CC)}$  | Cycle-to-Cycle Jitter<br>N = 00 ( $\div 1$ )<br>N = 01 ( $\div 2$ )<br>N = 10 ( $\div 4$ )<br>N = 11 ( $\div 8$ ) |      |     | 90  | ps   |            |
|                |                                                                                                                   |      |     | 130 | ps   |            |
|                |                                                                                                                   |      |     | 160 | ps   |            |
|                |                                                                                                                   |      |     | 190 | ps   |            |
| $t_{JIT(PER)}$ | Period Jitter<br>N = 00 ( $\div 1$ )<br>N = 01 ( $\div 2$ )<br>N = 10 ( $\div 4$ )<br>N = 11 ( $\div 8$ )         |      |     | 70  | ps   |            |
|                |                                                                                                                   |      |     | 120 | ps   |            |
|                |                                                                                                                   |      |     | 140 | ps   |            |
|                |                                                                                                                   |      |     | 170 | ps   |            |
| $t_{LOCK}$     | Maximum PLL Lock Time                                                                                             |      |     | 10  | ms   |            |

1. AC characteristics apply for parallel output termination of  $50 \Omega$  to  $V_{TT}$ .

2. The input frequency  $f_{XTAL}$  and the PLL feedback divider M must match the VCO frequency range:  $f_{VCO} = f_{XTAL} \times M$ .

3. The frequency of S\_CLOCK is limited to 10 MHz in serial programming mode. S\_CLOCK can be switched at higher frequencies when used as test clock in test mode 6. See [APPLICATIONS INFORMATION](#) for more details.

## PROGRAMMING INTERFACE

## Programming the MPC92429

Programming the MPC92429 amounts to properly configuring the internal PLL dividers to produce the desired synthesized frequency at the output. The output frequency can be represented by this formula:

$$F_{OUT} = (f_{XTAL} \div 16) \times (M) \div (N) \quad (1)$$

where  $f_{XTAL}$  is the crystal frequency, M is the PLL feedback-divider and N is the PLL post-divider. The input frequency and the selection of the feedback divider M is limited by the VCO-frequency range.  $f_{XTAL}$  and M must be configured to

match the VCO frequency range of 200 to 400 MHz in order to achieve stable PLL operation:

$$M_{MIN} = f_{VCO,MIN} \div f_{XTAL} \text{ and} \quad (2)$$

$$M_{MAX} = f_{VCO,MAX} \div f_{XTAL} \quad (3)$$

For instance, the use of a 16 MHz input frequency requires the configuration of the PLL feedback divider between M = 200 and M = 400. Table 7 shows the usable VCO frequency and M divider range for other example input frequencies. Assuming that a 16 MHz input frequency is used, equation 1 reduces to:

$$F_{OUT} = M \div N \quad (4)$$

Table 7. MPC92429 Frequency Operating Range

| M   | M[8:0]    | VCO frequency for an crystal interface frequency of |       |        |     |        |       | Output frequency for $f_{XTAL} = 16$ MHz and for N = |     |      |       |
|-----|-----------|-----------------------------------------------------|-------|--------|-----|--------|-------|------------------------------------------------------|-----|------|-------|
|     |           | 10                                                  | 12    | 14     | 16  | 18     | 20    | 1                                                    | 2   | 4    | 8     |
| 160 | 010100000 |                                                     |       |        |     |        | 200   |                                                      |     |      |       |
| 170 | 010101010 |                                                     |       |        |     |        | 212.5 |                                                      |     |      |       |
| 180 | 010110100 |                                                     |       |        |     | 202.5  | 225   |                                                      |     |      |       |
| 190 | 010111110 |                                                     |       |        |     | 213.75 | 237.5 |                                                      |     |      |       |
| 200 | 011001000 |                                                     |       |        | 200 | 225    | 250   | 200                                                  | 100 | 50   | 25    |
| 210 | 011010010 |                                                     |       |        | 210 | 236.25 | 262.5 | 210                                                  | 105 | 52.5 | 26.25 |
| 220 | 011011100 |                                                     |       |        | 220 | 247.5  | 275   | 220                                                  | 110 | 55   | 27.5  |
| 230 | 011100110 |                                                     |       | 201.25 | 230 | 258.75 | 287.5 | 230                                                  | 115 | 57.5 | 28.75 |
| 240 | 011110000 |                                                     |       | 210    | 240 | 270    | 300   | 240                                                  | 120 | 60   | 30    |
| 250 | 011111010 |                                                     |       | 218.75 | 250 | 281.25 | 312.5 | 250                                                  | 125 | 62.5 | 31.25 |
| 260 | 100000100 |                                                     |       | 227.5  | 260 | 292.5  | 325   | 260                                                  | 130 | 65   | 32.5  |
| 270 | 100001110 |                                                     | 202.5 | 236.25 | 270 | 303.75 | 337.5 | 270                                                  | 135 | 67.5 | 33.75 |
| 280 | 100011000 |                                                     | 210   | 245    | 280 | 315    | 350   | 280                                                  | 140 | 70   | 35    |
| 290 | 100100010 |                                                     | 217.5 | 253.75 | 290 | 326.25 | 362.5 | 290                                                  | 145 | 72.5 | 36.25 |
| 300 | 100101100 |                                                     | 225   | 262.5  | 300 | 337.5  | 375   | 300                                                  | 150 | 75   | 37.5  |
| 310 | 100110110 |                                                     | 232.5 | 271.25 | 310 | 348.75 | 387.5 | 310                                                  | 155 | 77.5 | 38.75 |
| 320 | 101000000 | 200                                                 | 240   | 280    | 320 | 360    | 400   | 320                                                  | 160 | 80   | 40    |
| 330 | 101001010 | 206.25                                              | 247.5 | 288.75 | 330 | 371.25 |       | 330                                                  | 165 | 82.5 | 41.25 |
| 340 | 101010100 | 212.5                                               | 255   | 297.5  | 340 | 382.5  |       | 340                                                  | 170 | 85   | 42.5  |
| 350 | 101011110 | 218.75                                              | 262.5 | 306.25 | 350 | 393.75 |       | 350                                                  | 175 | 87.5 | 43.75 |
| 360 | 101101000 | 225                                                 | 270   | 315    | 360 |        |       | 360                                                  | 180 | 90   | 45    |
| 370 | 101110010 | 231.25                                              | 277.5 | 323.75 | 370 |        |       | 370                                                  | 185 | 92.5 | 46.25 |
| 380 | 101111100 | 237.5                                               | 285   | 332.5  | 380 |        |       | 380                                                  | 190 | 95   | 47.5  |
| 390 | 110000110 | 243.75                                              | 292.5 | 341.25 | 390 |        |       | 390                                                  | 195 | 97.5 | 48.75 |
| 400 | 110010000 | 250                                                 | 300   | 350    | 400 |        |       | 400                                                  | 200 | 100  | 50    |
| 410 | 110011010 | 256.25                                              | 307.5 | 358.75 |     |        |       |                                                      |     |      |       |
| 420 | 110100100 | 262.5                                               | 315   | 367.5  |     |        |       |                                                      |     |      |       |
| 430 | 110101110 | 268.75                                              | 322.5 | 376.25 |     |        |       |                                                      |     |      |       |
| 440 | 110111000 | 275                                                 | 330   | 385    |     |        |       |                                                      |     |      |       |
| 450 | 111000010 | 281.25                                              | 337.5 | 393.75 |     |        |       |                                                      |     |      |       |
| 510 | 111111110 | 318.75                                              | 382.5 |        |     |        |       |                                                      |     |      |       |

Substituting N for the four available values for N (1, 2, 4, 8) yields:

**Table 8. Output Frequency Range for  $f_{XTAL} = 16$  MHz**

| N |   |       | F <sub>OUT</sub> | F <sub>OUT</sub> Range | F <sub>OUT</sub> Step |
|---|---|-------|------------------|------------------------|-----------------------|
| 1 | 0 | Value |                  |                        |                       |
| 0 | 0 | 1     | M                | 200 – 400 MHz          | 1 MHz                 |
| 0 | 1 | 2     | M÷2              | 100 – 200 MHz          | 500 kHz               |
| 1 | 0 | 4     | M÷4              | 50 – 100 MHz           | 250 kHz               |
| 1 | 1 | 8     | M÷8              | 25 – 50 MHz            | 125 kHz               |

### Example Frequency Calculation for an 16 MHz Input Frequency

If an output frequency of 131 MHz was desired the following steps would be taken to identify the appropriate M and N values. According to Table 8, 131 MHz falls in the frequency set by an value of 2 so N[1:0] = 01. For N = 2 the output frequency is  $F_{OUT} = M \div 2$  and  $M = F_{OUT} \times 2$ . Therefore  $M = 2 \times 131 = 262$ , so M[8:0] = 100000110. Following this procedure a user can generate any whole frequency between 25 MHz and 400 MHz. Note that for N > 2 fractional values of can be realized. The size of the programmable frequency steps (and thus the indicator of the fractional output frequencies achievable) will be equal to:

$$f_{STEP} = f_{XTAL} \div 16 \div N \quad (5)$$

## APPLICATIONS INFORMATION

### Using the Parallel and Serial Interface

The M and N counters can be loaded either through a parallel or serial interface. The parallel interface is controlled via the P\_LOAD signal such that a LOW-to-HIGH transition will latch the information present on the M[8:0] and N[1:0] inputs into the M and N counters. When the P\_LOAD signal is LOW the input latches will be transparent and any changes on the M[8:0] and N[1:0] inputs will affect the FOUT output pair. To use the serial port the S\_CLOCK signal samples the information on the S\_DATA line and loads it into a 14 bit shift register. Note that the P\_LOAD signal must be HIGH for the serial load operation to function. The Test register is loaded with the first three bits, the N register with the next two and the M register with the final eight bits of the data stream on the S\_DATA input. For each register the most significant bit is loaded first (T2, N1 and M8). A pulse on the S\_LOAD pin after the shift register is fully loaded will transfer the divide values into the counters. The HIGH-to-LOW transition on the S\_LOAD input will latch the new divide values into the counters. Figure 4 illustrates the timing diagram for both a parallel and a serial load of the MPC92429 synthesizer. M[8:0] and N[1:0] are normally specified once at power-up through the parallel interface, and then possibly again through the serial interface. This approach allows the application to come up at one frequency and then change or fine-tune the clock as the ability to control the serial interface becomes available.

### Using the Test and Diagnosis Output TEST

The TEST output provides visibility for one of the several internal nodes as determined by the T[2:0] bits in the serial configuration stream. It is not configurable through the parallel interface. Although it is possible to select the node that represents FOUT, the CMOS output is not able to toggle fast enough for higher output frequencies and should only be used for test and diagnosis. The T2, T1 and T0 control bits are preset to '000' when P\_LOAD is LOW so that the PECL FOUT outputs are as jitter-free as possible. Any active signal on the TEST output pin will have detrimental effects on the jitter of the PECL output pair. In normal operations, jitter specifications are only guaranteed if the TEST output is static. The serial configuration port can be used to select one of the alternate functions for this pin. Most of the signals available on the TEST output pin are useful only for

performance verification of the MPC92429 itself. However the PLL bypass mode may be of interest at the board level for functional debug. When T[2:0] is set to 110 the MPC92429 is placed in PLL bypass mode. In this mode the S\_CLOCK input is fed directly into the M and N dividers. The N divider drives the FOUT differential pair and the M counter drives the TEST output pin. In this mode the S\_CLOCK input could be used for low speed board level functional test or debug. Bypassing the PLL and driving FOUT directly gives the user more control on the test clocks sent through the clock tree. Figure 6 shows the functional setup of the PLL bypass mode. Because the S\_CLOCK is a CMOS level the input frequency is limited to 200 MHz. This means the fastest the FOUT pin can be toggled via the S\_CLOCK is 100 MHz as the divide ratio of the Post-PLL divider is 2 (if N = 1). Note that the M counter output on the TEST output will not be a 50% duty cycle.

**Table 9. Test and Debug Configuration for TEST**

| T[2:0] |    |    | TEST Output                              |
|--------|----|----|------------------------------------------|
| T2     | T1 | T0 |                                          |
| 0      | 0  | 0  | 14-bit shift register out <sup>(1)</sup> |
| 0      | 0  | 1  | Logic 1                                  |
| 0      | 1  | 0  | $f_{XTAL} \div 16$                       |
| 0      | 1  | 1  | M-Counter out                            |
| 1      | 0  | 0  | FOUT                                     |
| 1      | 0  | 1  | Logic 0                                  |
| 1      | 1  | 0  | M-Counter out in PLL-bypass mode         |
| 1      | 1  | 1  | $F_{OUT} \div 4$                         |

1. Clocked out at the rate of S\_CLOCK.

**Table 10. Debug Configuration for PLL Bypass<sup>(1)</sup>**

| Output | Configuration                |
|--------|------------------------------|
| FOUT   | S_CLOCK ÷ N                  |
| TEST   | M-Counter out <sup>(2)</sup> |

1. T[2:0] = 110. AC specifications do not apply in PLL bypass mode.

2. Clocked out at the rate of S\_CLOCK÷(4·N)

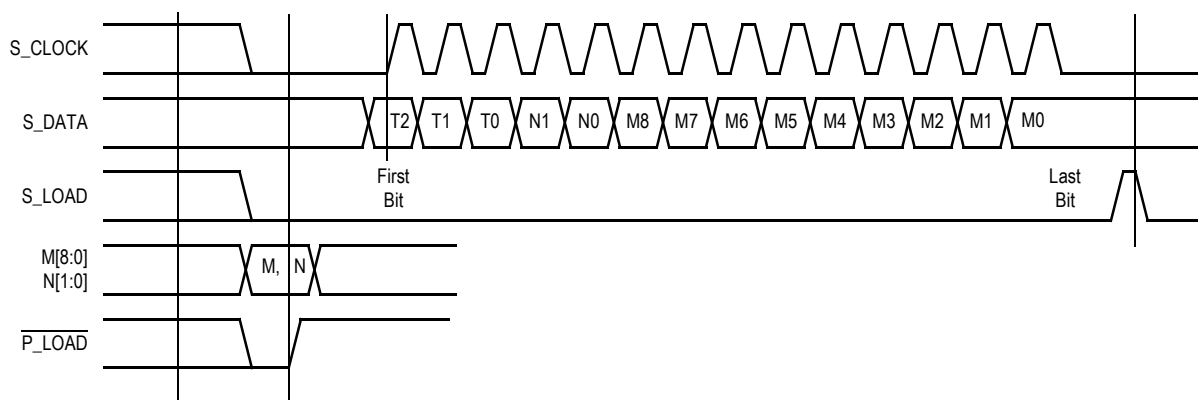
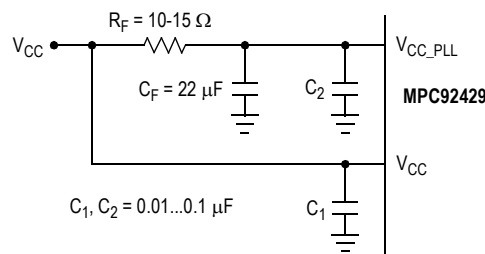


Figure 4. Serial Interface Timing Diagram

### Power Supply Filtering

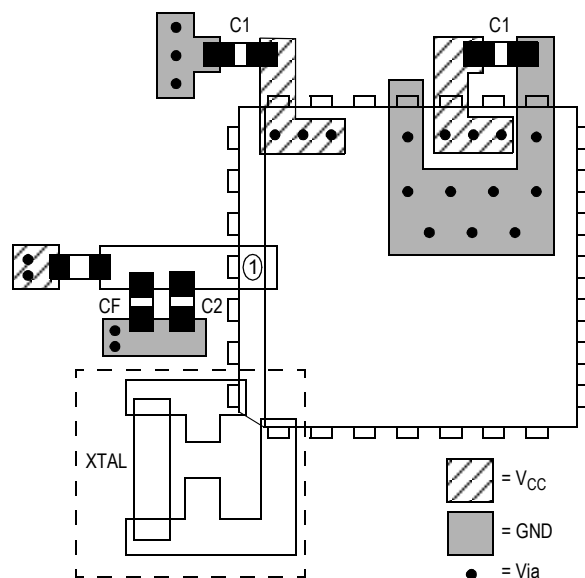
The MPC92429 is a mixed analog/digital product. Its analog circuitry is naturally susceptible to random noise, especially if this noise is seen on the power supply pins. Random noise on the  $V_{CC\_PLL}$  pin impacts the device characteristics. The MPC92429 provides separate power supplies for the digital circuitry ( $V_{CC}$ ) and the internal PLL ( $V_{CC\_PLL}$ ) of the device. The purpose of this design technique is to try and isolate the high switching noise digital outputs from the relatively sensitive internal analog phase-locked loop. In a controlled environment such as an evaluation board, this level of isolation is sufficient. However, in a digital system environment where it is more difficult to minimize noise on the power supplies a second level of isolation may be required. The simplest form of isolation is a power supply filter on the  $V_{CC\_PLL}$  pin for the MPC92429. Figure 5 illustrates a typical power supply filter scheme. The MPC92429 is most susceptible to noise with spectral content in the 1 kHz to 1 MHz range. Therefore, the filter should be designed to target this range. The key parameter that needs to be met in the final filter design is the DC voltage drop that will be seen between the  $V_{CC}$  supply and the MPC92429 pin of the MPC92429. From the data sheet, the  $V_{CC\_PLL}$  current (the current sourced through the  $V_{CC\_PLL}$  pin) is maximum 20 mA, assuming that a minimum of 2.835 V must be maintained on the  $V_{CC\_PLL}$  pin. The resistor shown in Figure 5 must have a resistance of 10-15  $\Omega$  to meet the voltage drop criteria. The RC filter pictured will provide a broadband filter with approximately 100:1 attenuation for noise whose spectral content is above 20 kHz. As the noise frequency crosses the series resonant point of an individual capacitor its overall impedance begins to look inductive and thus increases with increasing frequency. The parallel capacitor combination shown ensures that a low impedance path to ground exists for frequencies well above the bandwidth of the PLL. Generally, the resistor/capacitor filter will be cheaper, easier to implement and provide an adequate level of supply filtering. A higher level of attenuation can be achieved by replacing the resistor with an appropriate valued inductor. A 1000  $\mu$ H choke will show a significant impedance at 10 kHz frequencies and above. Because of the current draw and the voltage that must be maintained on the  $V_{CC\_PLL}$  pin, a low DC resistance inductor is required (less than 15  $\Omega$ ).

Figure 5.  $V_{CC\_PLL}$  Power Supply Filter

### Layout Recommendations

The MPC92429 provides sub-nanosecond output edge rates and thus a good power supply bypassing scheme is a must. Figure 6 shows a representative board layout for the MPC92429. There exists many different potential board layouts and the one pictured is but one. The important aspect of the layout in Figure 6 is the low impedance connections between  $V_{CC}$  and GND for the bypass capacitors. Combining good quality general purpose chip capacitors with good PCB layout techniques will produce effective capacitor resonances at frequencies adequate to supply the instantaneous switching current for the MPC92429 outputs. It is imperative that low inductance chip capacitors are used; it is equally important that the board layout does not introduce back all of the inductance saved by using the leadless capacitors. Thin interconnect traces between the capacitor and the power plane should be avoided and multiple large vias should be used to tie the capacitors to the buried power planes. Fat interconnect and large vias will help to minimize layout induced inductance and thus maximize the series resonant point of the bypass capacitors. Note the dotted lines circling the crystal oscillator connection to the device. The oscillator is a series resonant circuit and the voltage amplitude across the crystal is relatively small. It is imperative that no actively switching signals cross under the crystal as crosstalk energy coupled to these lines could significantly impact the jitter of the device. Special attention should be paid to the layout of the crystal to ensure a stable, jitter free interface between the crystal and the on-board oscillator. Although the MPC92429 has several design features to minimize the susceptibility to power supply noise (isolated power and grounds and fully differential PLL), there still may be applications in which

overall performance is being degraded due to system power supply noise. The power supply filter and bypass schemes discussed in this section should be adequate to eliminate power supply noise related problems in most designs.



**Figure 6. PCB Board Layout Recommendation for the PLCC28 Package**

#### The On-Chip Crystal Oscillator

The MPC92429 features an integrated on-chip crystal oscillator to minimize system implementation cost. The integrated oscillator is a Pierce-type that uses the crystal in its parallel resonance mode. It is recommended to use a 10 to 20 MHz crystal with a load specification of  $C_L = 10$  pF. Crystals with a load specification of  $C_L = 20$  pF may be used at the expense of an slightly higher frequency than specified for the crystal. Externally connected capacitors on both the XTAL\_IN and XTAL\_OUT pins are not required but can be used to fine-tune the crystal frequency as desired.

The crystal, the trace and optional capacitors should be placed on the board as close as possible to the MPC92429

XTAL\_IN and XTAL\_OUT pins to reduce crosstalk of active signals into the oscillator. Short and wide traces further reduce parasitic inductance and resistance. It is further recommended to guard the crystal circuit by placing a ground ring around the traces and oscillator components. See [Table 11](#) for recommended crystal specifications.

**Table 11. Recommended Crystal Specifications**

| Parameter                        | Value              |
|----------------------------------|--------------------|
| Crystal Cut                      | Fundamental AT Cut |
| Resonance Mode                   | Parallel           |
| Crystal Frequency                | 10–20 MHz          |
| Shunt Capacitance $C_0$          | 5–7 pF             |
| Load Capacitance $C_L$           | 10 pF              |
| Equivalent Series Resistance ESR | 20–60 $\Omega$     |

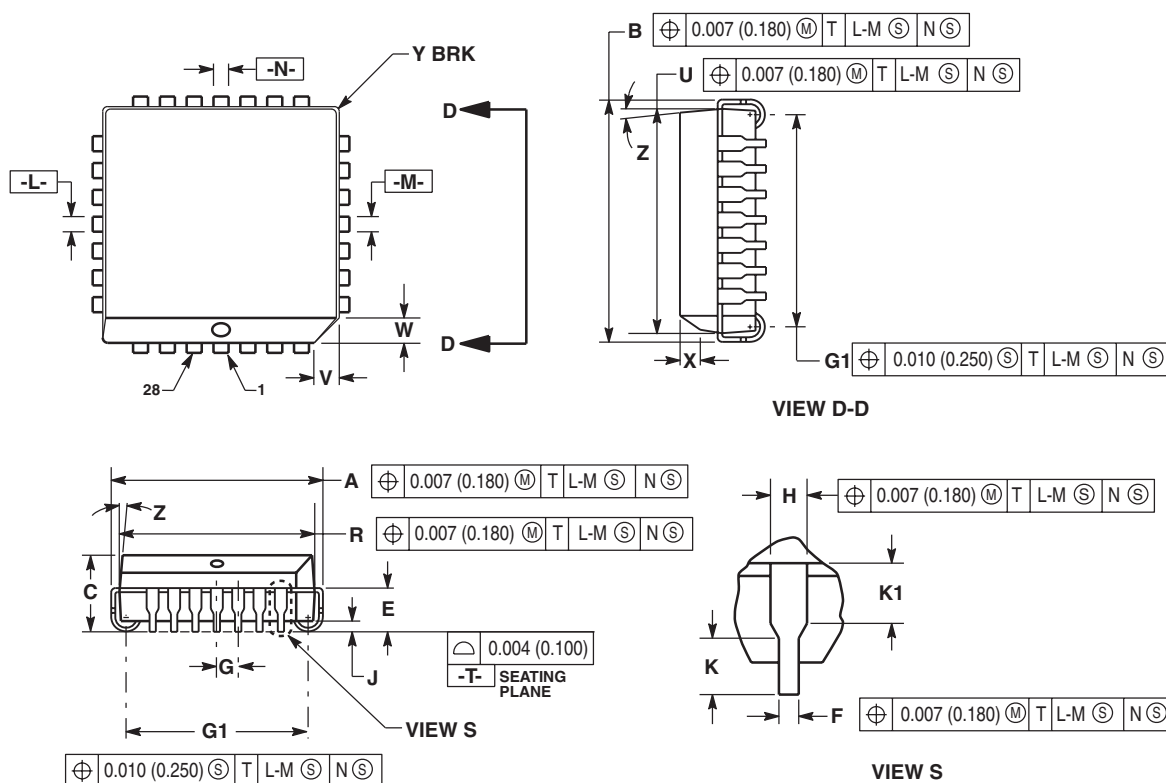
As an alternative to parallel resonance mode crystals, the oscillator also works with crystals specified in the series resonance mode. With series resonance crystals, the oscillator frequency and the synthesized output frequency of the MPC92429 will be a approximately 350–400 ppm higher than using crystals specified for parallel frequency mode.

This is applicable to applications using the MPC92429 in sockets designed for the pin and function compatible MC12429 synthesizer, which has an oscillator using the crystal in its series resonance mode. [Table 12](#) shows the recommended specifications for series resonance mode crystals.

**Table 12. Alternative Crystal Specifications**

| Parameter                        | Value              |
|----------------------------------|--------------------|
| Crystal Cut                      | Fundamental AT Cut |
| Resonance Mode                   | Series             |
| Crystal Frequency                | 10–20 MHz          |
| Shunt Capacitance $C_0$          | 5–7 pF             |
| Equivalent Series Resistance ESR | 50–80 $\Omega$     |

## PACKAGE DIMENSIONS



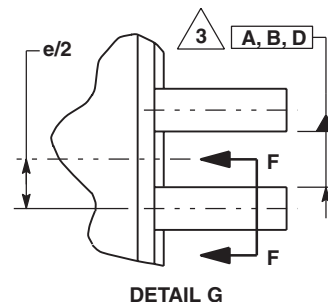
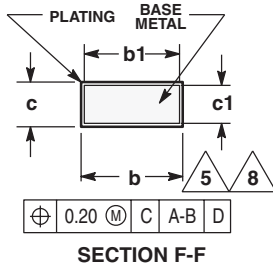
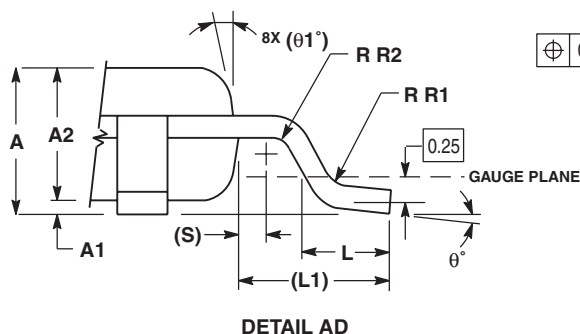
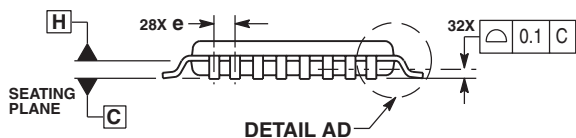
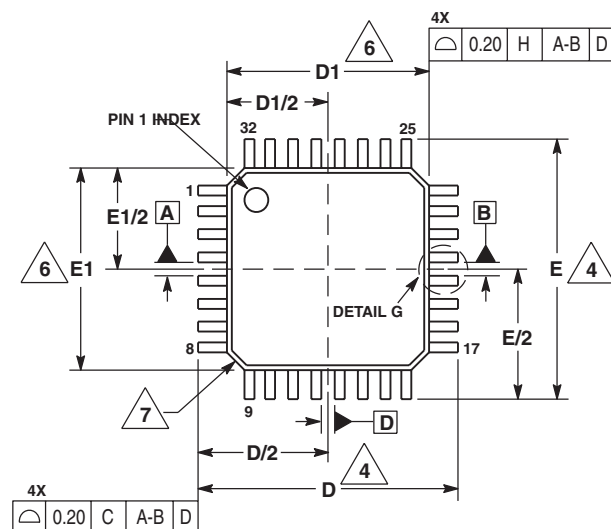
## NOTES:

- DATUMS -L-, -M-, AND -N- DETERMINED WHERE TOP OF LEAD SHOULDER EXISTS PLASTIC BODY AT MOLD PARTING LINE.
- DIMENSION G1, TRUE POSITION TO BE MEASURED AT DATUM -T-, SEATING PLANE.
- DIMENSIONS R AND U DO NOT INCLUDE MOLD FLASH. ALLOWABLE MOLD FLASH IS 0.010 (0.250) PER SIDE.
- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: INCH.
- THE PACKAGE TOP MAY BE SMALLER THAN THE PACKAGE BOTTOM BY UP TO 0.012 (0.300). DIMENSIONS R AND U ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.
- DIMENSION H DOES NOT INCLUDE DAMBAR PROTRUSION OR INTRUSION. THE DAMBAR PROTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE GREATER THAN 0.037 (0.940). THE DAMBAR INTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE SMALLER THAN 0.025 (0.635).

| DIM | INCHES    |       | MILLIMETERS |       |
|-----|-----------|-------|-------------|-------|
|     | MIN       | MAX   | MIN         | MAX   |
| A   | 0.485     | 0.495 | 12.32       | 12.57 |
| B   | 0.485     | 0.495 | 12.32       | 12.57 |
| C   | 0.165     | 0.180 | 4.20        | 4.57  |
| E   | 0.090     | 0.110 | 2.29        | 2.79  |
| F   | 0.013     | 0.019 | 0.33        | 0.48  |
| G   | 0.050 BSC |       | 1.27 BSC    |       |
| H   | 0.026     | 0.032 | 0.66        | 0.81  |
| J   | 0.020     | ---   | 0.51        | ---   |
| K   | 0.025     | ---   | 0.64        | ---   |
| R   | 0.450     | 0.456 | 11.43       | 11.58 |
| U   | 0.450     | 0.456 | 11.43       | 11.58 |
| V   | 0.042     | 0.048 | 1.07        | 1.21  |
| W   | 0.042     | 0.048 | 1.07        | 1.21  |
| X   | 0.042     | 0.056 | 1.07        | 1.42  |
| Y   | ---       | 0.020 | ---         | 0.50  |
| Z   | 2"        | 10"   | 2"          | 10"   |
| G1  | 0.410     | 0.430 | 10.42       | 10.92 |
| K1  | 0.040     | ---   | 1.02        | ---   |

**CASE 776-02**  
**ISSUE D**  
**28-LEAD PLCC PACKAGE**

## PACKAGE DIMENSIONS



- NOTES:
1. DIMENSIONS ARE IN MILLIMETERS.
  2. INTERPRET DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994.
  3. DATUMS A, B, AND D TO BE DETERMINED AT DATUM PLANE H.
  4. DIMENSIONS D AND E TO BE DETERMINED AT SEATING PLANE C.
  5. DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL NOT CAUSE THE LEAD WIDTH TO EXCEED THE MAXIMUM b DIMENSION BY MORE THAN 0.08-mm. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT. MINIMUM SPACE BETWEEN PROTRUSION AND ADJACENT LEAD OR PROTRUSION: 0.07-mm.
  6. DIMENSIONS D1 AND E1 DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE PROTRUSION IS 0.25-mm PER SIDE. D1 AND E1 ARE MAXIMUM PLASTIC BODY SIZE DIMENSIONS INCLUDING MOLD MISMATCH.
  7. EXACT SHAPE OF EACH CORNER IS OPTIONAL.
  8. THESE DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.1-mm AND 0.25-mm FROM THE LEAD TIP.

| MILLIMETERS |      |      |
|-------------|------|------|
| DIM         | MIN  | MAX  |
| A           | 1.40 | 1.60 |
| A1          | 0.05 | 0.15 |
| A2          | 1.35 | 1.45 |
| b           | 0.30 | 0.45 |
| b1          | 0.30 | 0.40 |
| c           | 0.09 | 0.20 |
| c1          | 0.09 | 0.16 |
| D           | 9.00 | BSC  |
| D1          | 7.00 | BSC  |
| e           | 0.80 | BSC  |
| E           | 9.00 | BSC  |
| E1          | 7.00 | BSC  |
| L           | 0.50 | 0.70 |
| L1          | 1.00 | REF  |
| q           | 0°   | 7°   |
| q1          | 12   | REF  |
| R1          | 0.08 | 0.20 |
| R2          | 0.08 | ---  |
| S           | 0.20 | REF  |

CASE 873A-03  
ISSUE B  
32-LEAD LQFP PACKAGE

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